Product data sheet

1. Product profile

1.1 General description

Hybrid high dynamic range amplifier module operating at a supply voltage of 24 V Direct Current (DC) in a SOT115J package. The module consists of two cascaded stages both in cascode configuration.

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features

- Excellent linearity
- Extremely low noise
- High gain
- Excellent return loss properties

1.3 Applications

Single module line extender in CATV systems operating in the 40 MHz to 860 MHz frequency range.

1.4 Quick reference data

Table 1.Quick reference dataBandwidth 40 MHz to 860 MHz; $V_B = 24$ V; $T_{mb} = 30 \circ C$; $Z_S = Z_L = 75 \Omega$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	f = 50 MHz	33.5	-	34.5	dB
		f = 860 MHz	34	-	-	dB
I _{tot}	total current		<u>[1]</u> -	-	340	mA

[1] The module normally operates at $V_B = 24$ V, but is able to withstand supply transients up to 30 V.



2. Pinning information

Table 2.	Pinning	
Pin	Description	Simplified outline Graphic Symbol
1	input	
2	common	
3	common	
5	+V _B	
7	common	2 3 7 8 sym095
8	common	
9	output	

3. Ordering information

Table 3. Ordering information						
Type number	Package	ickage				
	Name	Description	Version			
BGY835C	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads	SOT115J			

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
VB	supply voltage		-	25	V
Vi	input voltage		-	55	dBmV
T _{stg}	storage temperature		-40	+100	°C
T _{mb}	mounting base temperature		-20	+100	°C

5. Characteristics

Table 5. Characteristics

Bandwidth 40 MHz to 860 MHz; $V_B = 24$ V; $T_{mb} = 30 \circ C$; $Z_S = Z_L = 75 \Omega$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
G _p	power gain	f = 50 MHz	33.5	5 -	34.5	dB
		f = 860 MHz	34	-	-	dB
SL	slope cable equivalent	f = 40 MHz to 860 MHz	0.5	-	2.5	dB
FL	flatness of frequency response	f = 40 MHz to 860 MHz	-0.5	5 -	+0.5	dB
RL _{in}	input return loss	f = 40 MHz to 80 MHz	20	-	-	dB
		f = 80 MHz to 160 MHz	18.5	5 -	-	dB
		f = 160 MHz to 320 MHz	17	-	-	dB
		f = 320 MHz to 640 MHz	15.5	5 -	-	dB
		f = 640 MHz to 860 MHz	14	-	-	dB
RL _{out}	output return loss	f = 40 MHz to 80 MHz	20	-	-	dB
		f = 80 MHz to 160 MHz	18.5	5 -	-	dB
		f = 160 MHz to 320 MHz	17	-	-	dB
		f = 320 MHz to 640 MHz	15.5	5 -	-	dB
		f = 640 MHz to 860 MHz	14	-	-	dB
φ s21	phase response	f = 50 MHz	135	-	225	deg
СТВ	composite triple beat	measured at f = 859.25 MHz	<u>[1]</u> _	-	-60	dB
CSO	composite second-order distortion	measured at f = 860.5 MHz	<u>[1]</u> _	-	-55	dB
NF	noise figure	f = 50 MHz	-	-	4.5	dB
		f = 860 MHz	-	-	7	dB
I _{tot}	total current		[2] _	-	340	mA

[1] 49 channels; $V_o = 44$ dBmV, flat output level.

[2] The module normally operates at V_B = 24 V, but is able to withstand supply transients up to 30 V.

BGY835C CATV amplifier module

6. Package outline

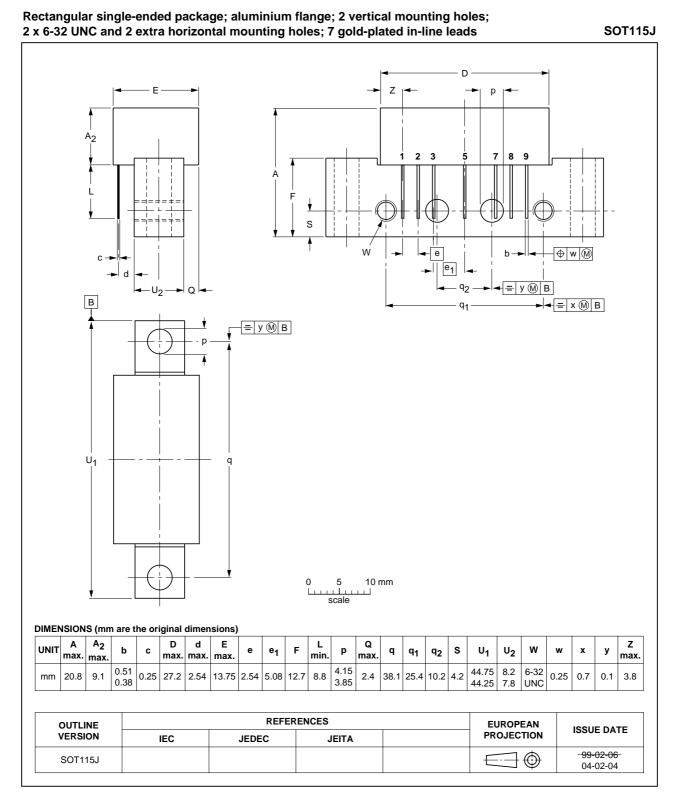


Fig 1. Package outline SOT115J

CATV amplifier module

7. Abbreviations

Table 6.	Abbreviations	
Acronym	Description	
CATV	Community Antenna TeleVision	
UNC	UNified Coarse	

8. Revision history

Table 7.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGY835C_1	20080908	Product data sheet	-	-

9. Legal information

9.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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BGY835C

11. Contents

1	Product profile 1
1.1	General description
1.2	Features
1.3	Applications 1
1.4	Quick reference data 1
2	Pinning information 2
3	Ordering information 2
4	Limiting values 2
5	Characteristics 3
6	Package outline 4
7	Abbreviations 5
8	Revision history 5
9	Legal information 6
9.1	Data sheet status 6
9.2	Definitions 6
9.3	Disclaimers 6
9.4	Trademarks6
10	Contact information 6
11	Contents 7

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